



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

#9/Election  
R.2  
1/30/03

In re Patent Application of:  
VINSON ET AL.

Serial No. 09/915,762

Examiner: T. Dinh

Filing Date: July 26, 2001

For: DECOUPLING CAPACITOR CLOSELY  
COUPLED WITH INTEGRATED  
CIRCUIT

Art Unit: 2827

SECOND RESPONSE TO REQUIREMENT FOR RESTRICTION

Director, U.S. Patent and Trademark Office  
Washington, DC 20231

Sir:

Applicants filed an initial Response to Restriction Requirement of October 1, 2002, electing Group I, Claims 1-31, drawn to an integrated chip module and multi-chip module, classified in class 361, subclass 782.

On December 31, 2002, the Examiner mailed a detailed action requesting that Applicants supply a correction by electing a single disclosed species for prosecution on the merits, i.e., either Specie I relative to FIG. 4: without a thin film metallization layer positioned on the capacitor carrier; or Specie II relative to FIG. 4A: with a thin film metallization layer positioned on the capacitor carrier.

Applicants elect Species I directed to FIG. 4: without a thin film metallization layer positioned on the capacitor carrier.

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If the Examiner has any questions concerning this response, the undersigned attorney would appreciate a telephone call.

Respectfully submitted,

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**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: **DIRECTOR, U.S. PATENT AND TRADEMARK OFFICE, WASHINGTON, DC 20231**, on this 15<sup>th</sup> day of January, 2003.